

### DESCRIPTION

The MP2014 is a low power linear regulator that supplies power to systems with high voltage batteries. It includes a wide 3V to 40V input range, low dropout voltage and low quiescent supply current. The low quiescent current and low dropout voltage allow operations at extremely low power levels. Therefore, the MP2014 is ideal for the low power microcontrollers and the battery-powered equipments.

The MP2014 provides wide variety of fixed output voltage options (if request): 1.8V, 1.9V, 2.3V, 2.5V, 3.0V, 3.3V, 3.45V, 5.0V.

The regulator output current is internally limited and the device is protected against short-circuit, over-load and over-temperature conditions.

The MP2014 also includes thermal shutdown and current limiting fault protection, and is available in TO252-5 package.

### FEATURES

- 3V to 40V Input Range
- 10 $\mu$ A Quiescent Supply Current
- Stable with Low-Value Output Ceramic Capacitor ( $>0.47\mu$ F)
- 500mA Specified Current
- Fixed Output Voltage
- Output  $\pm 2\%$  Accuracy
- Specified Current Limit
- Power Good
- Programmable Power Good Delay
- Thermal Shutdown and Short-Circuit Protection
- $-40^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$  Specified Junction Temperature Range
- Available in TO252-5 Package

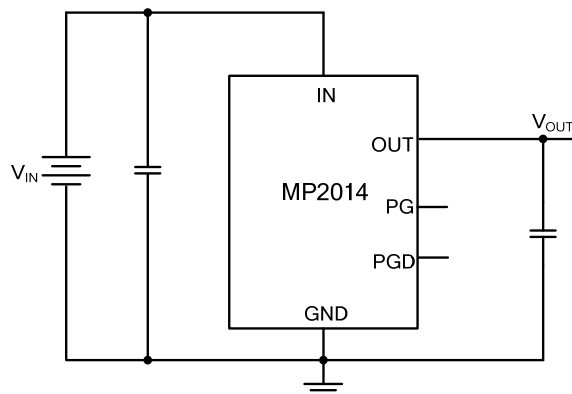
### APPLICATIONS

- Industrial/Automotive Applications
- Portable/Battery-Powered Equipment
- Ultra Low Power Microcontrollers
- Cellular Handsets
- Medical Imaging

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### TYPICAL APPLICATION



## ORDERING INFORMATION

| Part Number* | Package | Top Marking |
|--------------|---------|-------------|
| MP2014GZD    | TO252-5 | See Below   |
| MP2014GZD-33 | TO252-5 | See Below   |

\* For Tape & Reel, add suffix -Z (e.g. MP2014GZD-Z)

## TOP MARKING (MP2014GZD)

**MPSYYWW**  
**MP2014**  
**LLLLLLLLLL**

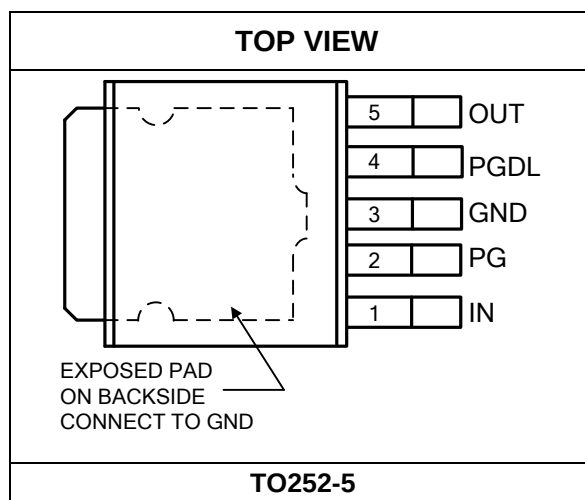
MPS: MPS Prefix  
 YY: Year Code  
 WW: Week Code  
 MP2014: Product Code of MP2014GZD  
 LLLLLLLLLL: Lot Number

## TOP MARKING (MP2014GZD-33)

**MPS YYWW**  
**MP2014-33**  
**LLLLLLLLLL**

MPS: MPS Prefix  
 YY: Year Code  
 WW: Week Code  
 MP2014-33: Product Code of MP2014GZD-33  
 LLLLLLLLLL: Lot Number

## PACKAGE REFERENCE



## ABSOLUTE MAXIMUM RATINGS <sup>(1)</sup>

|                                                                      |                 |
|----------------------------------------------------------------------|-----------------|
| IN .....                                                             | -0.3V to +42V   |
| OUT .....                                                            | -0.3V to +17V   |
| PG .....                                                             | -0.3V to +15V   |
| PGDL .....                                                           | -0.3V to +6V    |
| Lead Temperature .....                                               | 260°C           |
| Storage Temperature .....                                            | -65°C to +150°C |
| Continuous Power Dissipation (T <sub>A</sub> = +25°C) <sup>(2)</sup> |                 |
| TO252-5 .....                                                        | 2.27W           |

## ESD SUSCEPTIBILITY <sup>(3)</sup>

|                             |      |
|-----------------------------|------|
| HBM (Human Body Mode) ..... | 4kV  |
| MM (Machine Mode) .....     | 200V |

## Recommended Operating Conditions <sup>(4)</sup>

|                                      |                                          |
|--------------------------------------|------------------------------------------|
| Supply Voltage V <sub>IN</sub> ..... | 3V to 40V                                |
| Operating Temperature .....          | T <sub>A</sub> = -40°C to +125°C         |
|                                      | T <sub>A</sub> ≤ T <sub>J</sub> ≤ +150°C |

| Thermal Resistance <sup>(5)</sup> | θ <sub>JA</sub> | θ <sub>JC</sub> |
|-----------------------------------|-----------------|-----------------|
| TO252-5 .....                     | 55 .....        | 3 .....         |

### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub> (MAX), the junction-to-ambient thermal resistance θ<sub>JA</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub> (MAX) = (T<sub>J</sub> (MAX) - T<sub>A</sub>) / θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) Devices are ESD sensitive. Handling precaution recommended.
- 4) The device is not guaranteed to function outside of its operating conditions.
- 5) Measured on JESD51-7, 4-layer PCB.

## ELECTRICAL CHARACTERISTICS

$V_{IN}=13.5V$ ,  $T_J = +25^{\circ}C$ , unless otherwise noted.

| Parameter                                  | Symbol          | Condition                                                          | Min   | Typ  | Max   | Units       |
|--------------------------------------------|-----------------|--------------------------------------------------------------------|-------|------|-------|-------------|
| GND Pin Current                            | $I_{GND}$       | $0 < I_{OUT} < 1mA$                                                |       | 12   | 17    | $\mu A$     |
|                                            |                 | $1mA < I_{OUT} < 30mA$                                             |       | 16   | 22    |             |
|                                            |                 | $30mA < I_{OUT} < 500mA$                                           |       | 105  | 150   |             |
| Load Current Limit                         | $I_{LIMIT}$     | $V_{OUT} = 0V$                                                     | 550   | 900  | 1450  | mA          |
| Output Voltage accuracy                    |                 | MP2014GZD, $V_{IN} = 6V$ to $40V$ ,<br>$I_{LOAD} = 5mA$            | 4.9   | 5    | 5.1   | V           |
|                                            |                 | MP2014GZD-33, $V_{IN} = 4.3V$ to $40V$ ,<br>$I_{LOAD} = 5mA$       | 3.234 | 3.3  | 3.366 |             |
| Dropout Voltage <sup>(6)</sup>             | $V_{DROPOUT}$   | MP2014GZD, $I_{LOAD} = 300mA$ ,<br>$V_{DROPOUT} = V_{IN} - V_O$    |       | 400  | 650   | mV          |
|                                            |                 | MP2014GZD-33, $I_{LOAD} = 300mA$ ,<br>$V_{DROPOUT} = V_{IN} - V_O$ |       | 500  | 700   |             |
|                                            |                 | MP2014GZD, $I_{LOAD} = 500mA$ ,<br>$V_{DROPOUT} = V_{IN} - V_O$    |       | 750  | 1000  |             |
|                                            |                 | MP2014GZD-33, $I_{LOAD} = 500mA$ ,<br>$V_{DROPOUT} = V_{IN} - V_O$ |       | 1000 | 1300  |             |
| Line Regulation                            |                 | $V_{IN} = 8V$ to $40V$ , $I_{LOAD} = 5mA$                          | -10   | 1    | 10    | mV          |
| Load Regulation                            |                 | $I_{LOAD} = 5mA$ to $500mA$                                        |       | 1    | 15    | mV          |
| Output Voltage PSRR <sup>(7)</sup>         |                 | 100Hz, $C_{OUT} = 10\mu F$ , $I_{LOAD} = 10mA$                     |       | 57   |       | dB          |
|                                            |                 | 1kHz, $C_{OUT} = 10\mu F$ , $I_{LOAD} = 10mA$                      |       | 45   |       | dB          |
|                                            |                 | 100kHz, $C_{OUT} = 10\mu F$ , $I_{LOAD} = 10mA$                    |       | 51   |       | dB          |
| Startup Response Time                      |                 | MP2014GZD, $I_{LOAD} = 10mA$ ,<br>$C_{OUT} = 22\mu F$              |       | 1    | 2     | ms          |
|                                            |                 | MP2014GZD-33, $I_{LOAD} = 10mA$ ,<br>$C_{OUT} = 22\mu F$           |       | 0.6  | 1.5   |             |
| PG Rising Threshold                        |                 |                                                                    | 90%   | 93%  | 96%   | $V_{OUT}$   |
| PG Rising Threshold Hysteresis             |                 |                                                                    |       | 5%   |       | $V_{OUT}$   |
| PG Low Voltage                             |                 | Sink 1mA current                                                   |       | 0.1  | 0.4   | V           |
| PG Leakage Current                         |                 | $V_{PG} = 5V$                                                      |       |      | 1     | $\mu A$     |
| PGDL Charging Current                      | $I_{PGDL}$      | $V_{PGDL} = 1V$                                                    | 3     | 5.5  | 9     | $\mu A$     |
| PGDL Rising Threshold                      |                 |                                                                    | 1.5   | 1.65 | 2     | V           |
| PGDL Falling Threshold                     |                 |                                                                    | 0.2   | 0.4  | 0.7   | V           |
| PG Delay Time                              | $t_{PGDL}$      | $C_{PGDL} = 47nF$ ,<br>10% to 90% PGDL Rising Threshold            | 6     | 11   | 14    | ms          |
| PG Reaction Time                           |                 | $C_{PGDL} = 47nF$                                                  |       | 0.5  | 2     | $\mu s$     |
| Thermal Shutdown <sup>(7)</sup>            | $T_{SD}$        |                                                                    |       | 165  |       | $^{\circ}C$ |
| Thermal Shutdown Hysteresis <sup>(7)</sup> | $\Delta T_{SD}$ |                                                                    |       | 30   |       | $^{\circ}C$ |

### Notes:

6) Dropout voltage: Measured when the output voltage  $V_{OUT}$  has dropped 100mV from the nominal value obtained at  $V_{IN}=13.5V$ .

7) Derived from bench characterization. Not tested in production.

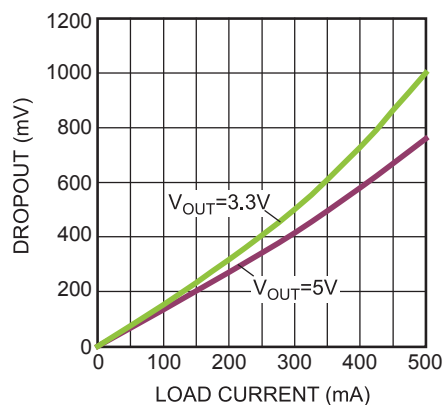
## PIN FUNCTIONS

| Pin # | Name | Description                                                                                                                |
|-------|------|----------------------------------------------------------------------------------------------------------------------------|
| 1     | IN   | Input voltage. Connect a 3V to 40V supply to this pin.                                                                     |
| 2     | PG   | Power good.                                                                                                                |
| 3     | GND  | Ground (internally connected to the exposed pad, GND pin and the exposed pad must be connected to the same ground plane)   |
| 4     | PGDL | Programmable power good delay time.                                                                                        |
| 5     | OUT  | Regulated output voltage, only low-value ceramic capacitor ( $\geq 0.47\mu\text{F}$ ) on output is required for stability. |

## TYPICAL PERFORMANCE CHARACTERISTICS

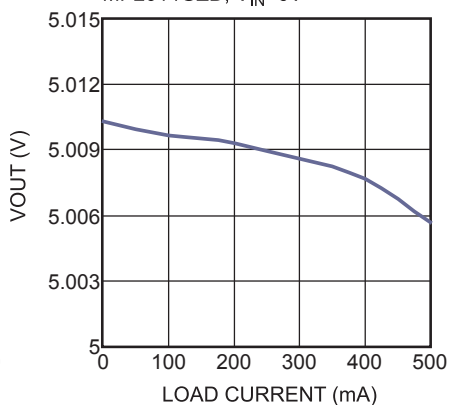
$C_{IN} = 1\mu F$ ,  $C_{OUT} = 22\mu F$ ,  $V_{OUT} = 5V$ ,  $T_A = 25^\circ C$ , unless otherwise noted.

**Dropout vs. Load Current**



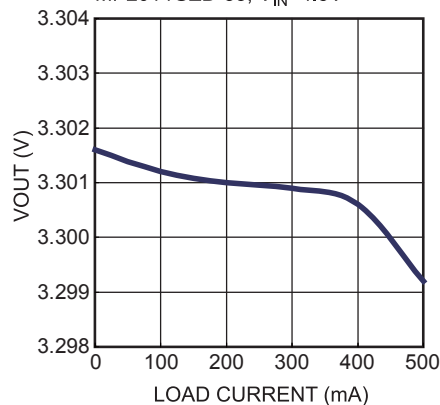
**$V_{OUT}$  vs.  $I_{OUT}$**

MP2014GZD,  $V_{IN} = 6V$



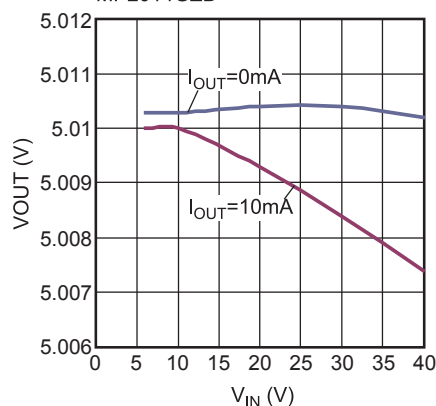
**$V_{OUT}$  vs.  $I_{OUT}$**

MP2014GZD-33,  $V_{IN} = 4.5V$



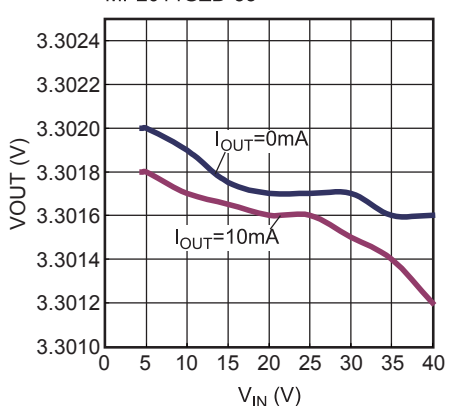
**$V_{OUT}$  vs.  $V_{IN}$**

MP2014GZD



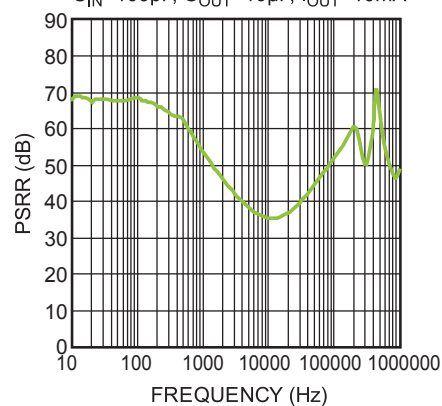
**$V_{OUT}$  vs.  $V_{IN}$**

MP2014GZD-33



**PSRR vs. Frequency**

$C_{IN} = 100pF$ ,  $C_{OUT} = 10\mu F$ ,  $I_{OUT} = 10mA$

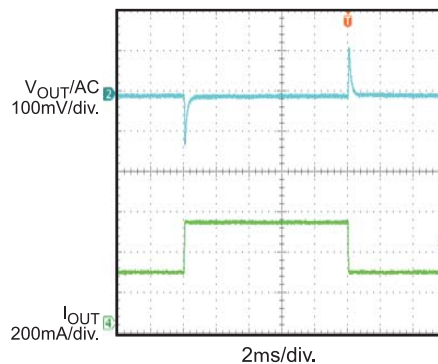


# **TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

$C_{IN} = 1\mu F$ ,  $C_{OUT} = 22\mu F$ ,  $V_{OUT} = 5V$ ,  $T_A = 25^\circ C$ , unless otherwise noted.

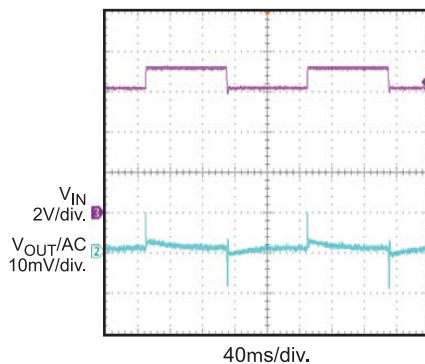
## **Load Transient**

$V_{IN}=12V$ ,  $I_{OUT}=250mA-500mA$



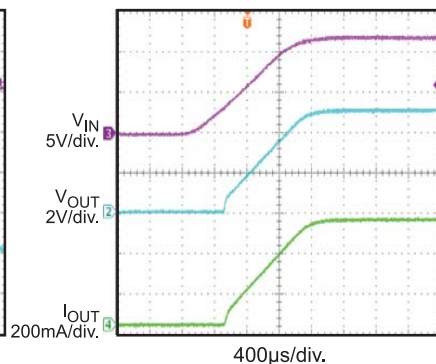
## **Line Transient**

$V_{IN}=6V-7V$ ,  $I_{OUT}=500mA$



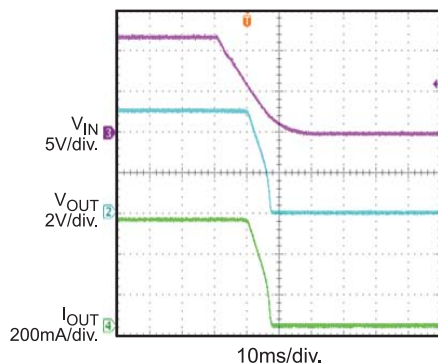
## **Start-Up through $V_{IN}$**

$V_{IN}=12V$ ,  $I_{OUT}=500mA$



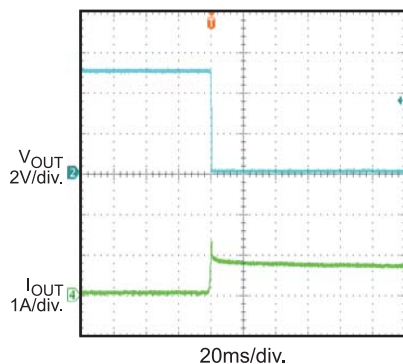
## **Shutdown through $V_{IN}$**

$V_{IN}=12V$ ,  $I_{OUT}=500mA$



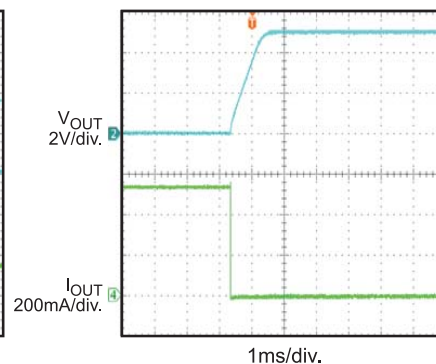
## **Short-Circuit Entry**

$I_{OUT}=0mA$  to Short Circuit



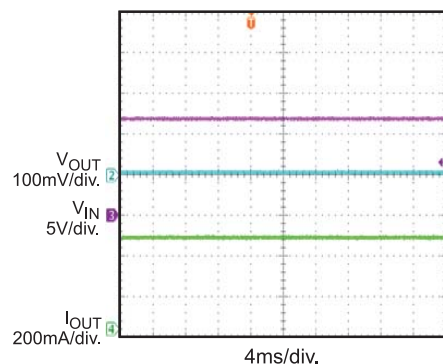
## **Short-Circuit Recovery**

Short Circuit to  $I_{OUT}=0mA$



## **Short-Circuit Steady State**

$V_{IN}=12V$



## OPERATION

The MP2014 is a linear regulator that supplies power to systems with high voltage batteries. It includes a wide 3V to 40V input range, low dropout voltage and low quiescent supply current.

The MP2014 provides wide variety of fixed output voltage options: 1.8V, 1.9V, 2.3V, 2.5V, 3.0V, 3.3V, 3.45V, 5.0V.

### Short-Circuit Protection

The regulator output current is internally limited and the device is protected against short-circuit, over-load. The peak output current is limited to around 900mA, which exceeds the 500mA recommended continuous output current.

### Thermal Shutdown

When the junction temperature exceeds the upper threshold (165°C), the thermal sensor sends a signal to the control logic to shutdown the IC. The IC will restart when the temperature has sufficiently cooled (135°C).

The maximum power output current is a function of the package's maximum power dissipation for a given temperature.

The maximum power dissipation is dependent on the thermal resistance of the case and the

circuit board, the temperature difference between the die junction and the ambient air, and the rate of air flow. The GND pin and Exposed Pad must be connected to the ground plane for proper dissipation.

### Power Good Output

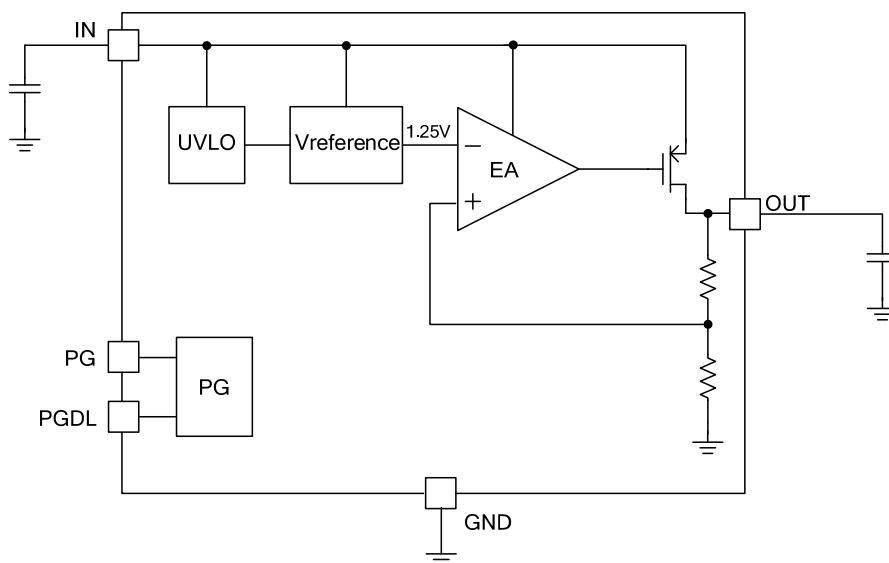
MP2014 has one power good (PG) pin. The PG pin is the open drain of an internal MOSFET. It should be connected to  $V_{OUT}$  or external voltage source (<15V) through a resistor (i.e. 100kohm). After the  $V_{OUT}$  reaches 93% of nominal value, the MOSFET turns off and PG pin is pulled to high by  $V_{OUT}$  or external voltage source. When the  $V_{OUT}$  drops to 88% of nominal value, the PG voltage is pulled to GND.

There is a delay time when PG asserts high. The delay time can be programmed by adding a capacitor on PGDL. To select a capacitor for PGDL, use below equation:

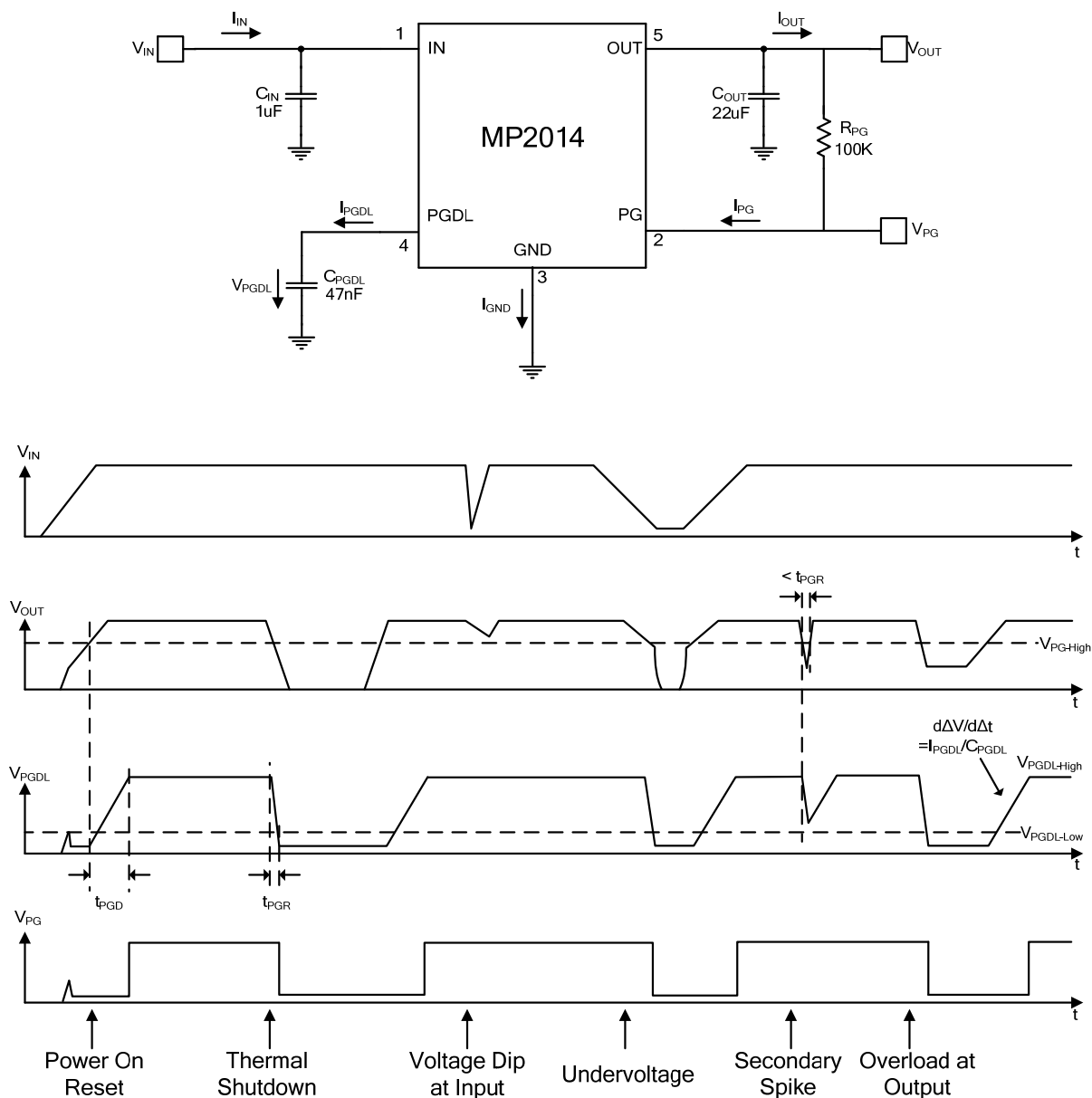
$$C_{PGDL} (nF) = \frac{t_{PGDL} (ms) \times I_{PGDL} (\mu A)}{V_{th\_PGDL} (V)}$$

Where  $t_{PGDL}$  is the desired delay time for PG asserts high,  $I_{PGDL}$  is the PGDL charging current and  $V_{th\_PGDL}$  is 1.65V.

Figure 2 shows the power good timing.



**Figure 1: Functional Block Diagram**



**Figure 2: Power Good Timing**

## APPLICATION INFORMATION

### Component Selection

#### Input Capacitor

For proper operation, place a ceramic capacitor (C1) between  $1\mu\text{F}$  and  $10\mu\text{F}$  of dielectric type X5R or X7R between the input pin and ground. Larger values in this range will help improve line transient response.

#### Output Capacitor

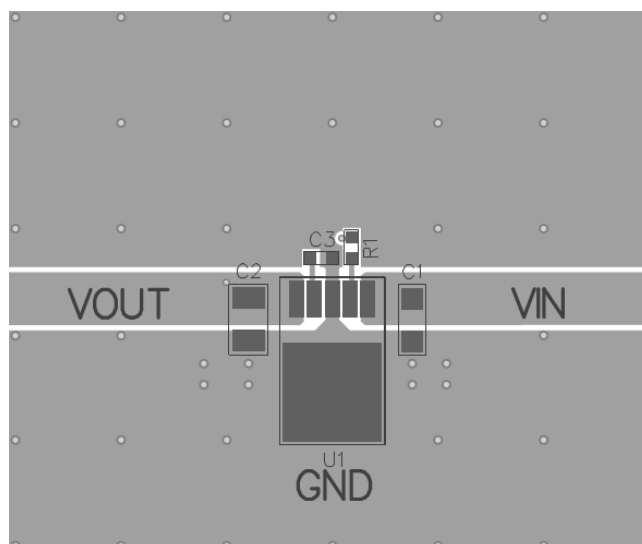
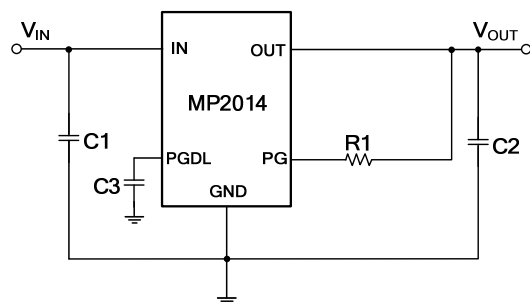
For stable operation, use a ceramic capacitor (C2) of type X5R or X7R between  $1\mu\text{F}$  and  $22\mu\text{F}$ . Larger values in this range will help improve load transient response and reduce noise. Output capacitors of other dielectric types may be used, but are not recommended as their capacitance can deviate greatly from their rated value over temperature.

### PCB Layout Guide

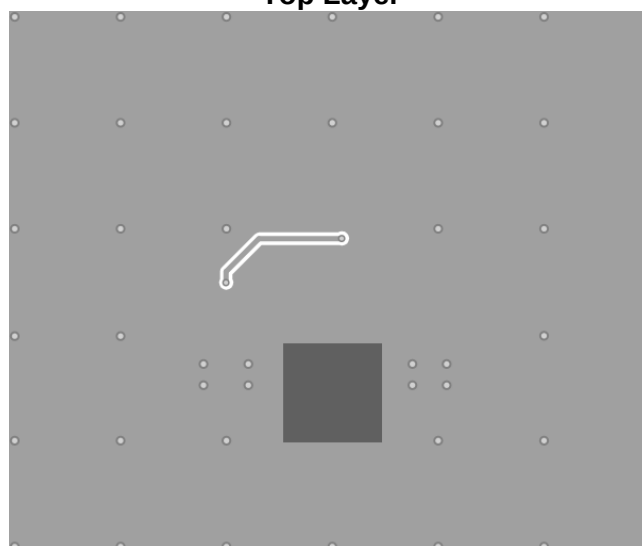
PCB layout is very important to achieve good regulation, ripple rejection, transient response and thermal performance. It is highly recommended to duplicate EVB layout for optimum performance.

If change is necessary, please follow these guidelines and take figure 3 for reference.

- 1) Input and output bypass ceramic capacitors are suggested to be put close to the IN Pin and OUT Pin respectively.
- 2) Connect IN, OUT and especially GND respectively to a large copper area to cool the chip to improve thermal performance and long-term reliability.



Top Layer



Bottom Layer

Figure 3: PCB Layout

## DESIGN EXAMPLE

Below is a design example following the application guidelines.

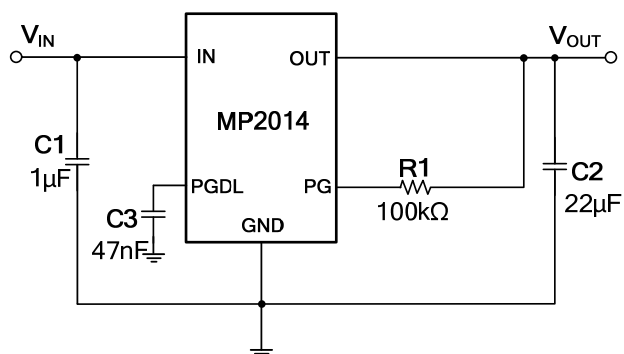


Figure 4: Design Example

## TYPICAL APPLICATION CIRCUITS

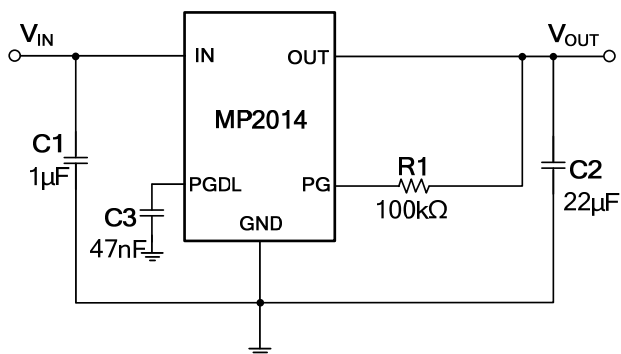
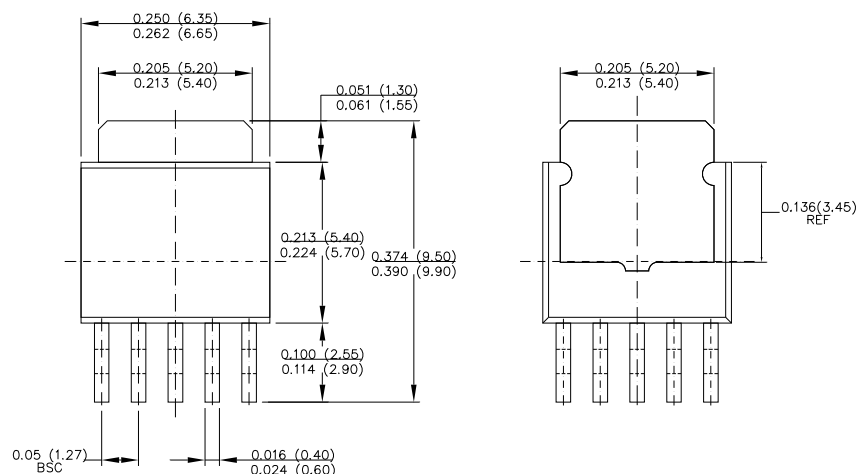


Figure 5: Typical Application Circuit

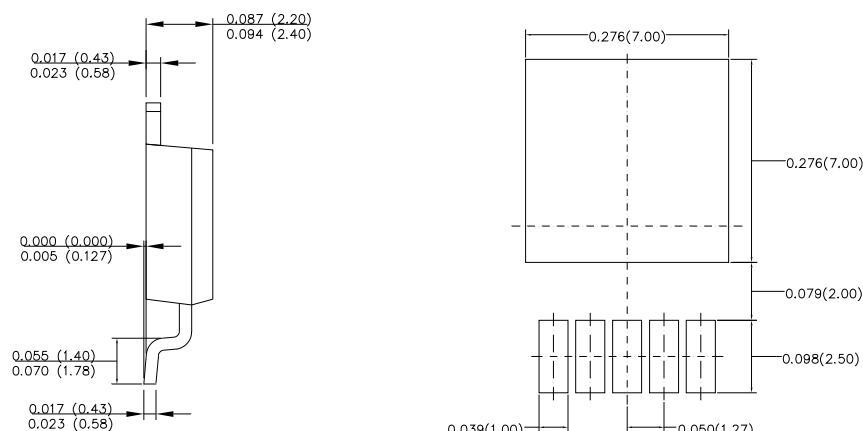
# PACKAGE INFORMATION

## TO252-5



**TOP VIEW**

**BOTTOM VIEW**



**SIDE VIEW**

**RECOMMENDED LAND PATTERN**

### NOTE:

- 1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
- 4) DRAWING CONFORMS TO JEDEC TO-252.
- 5) DRAWING IS NOT TO SCALE.

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